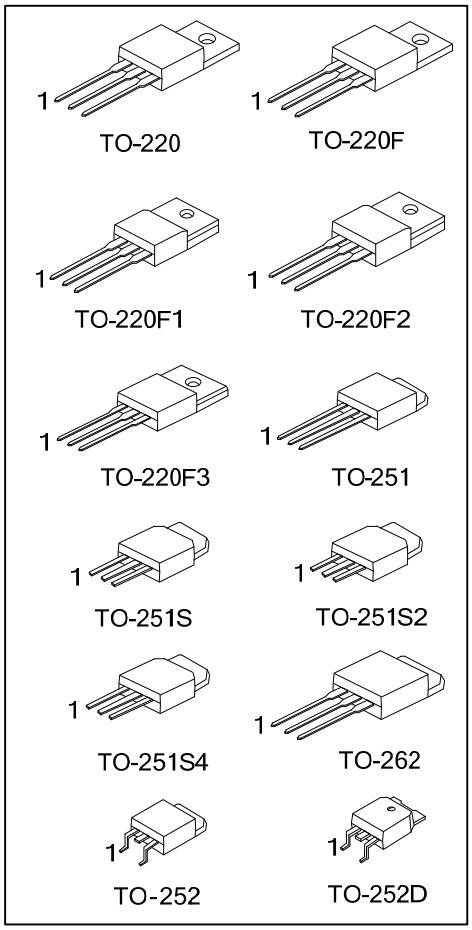
4N60K-MT

Preliminary ***Power MOSFET***

4.0A, 600V N-CHANNEL POWER MOSFET



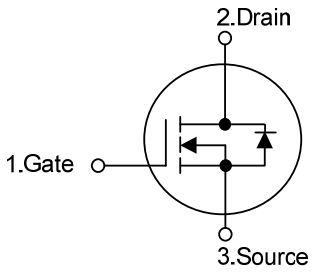
■ DESCRIPTION

The UTC **4N60K-MT** is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

■ FEATURES

* $R_{DS(ON)}$ < 2.5Ω @ V_{GS} = 10 V, I_D = 2.2 A
* Fast Switching Capability
* Avalanche Energy Specified
* Improved dv/dt Capability, high Ruggedness

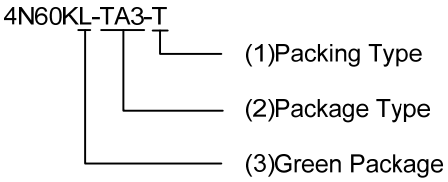
■ SYMBOL



■ ORDERING INFORMATION

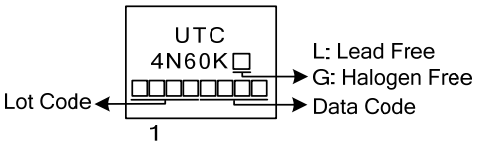
Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
4N60KL-TA3-T	4N60KG-TA3-T	TO-220	G	D	S	Tube
4N60KL-TF3-T	4N60KG-TF3-T	TO-220F	G	D	S	Tube
4N60KL-TF1-T	4N60KG-TF1-T	TO-220F1	G	D	S	Tube
4N60KL-TF2-T	4N60KG-TF2-T	TO-220F2	G	D	S	Tube
4N60KL-TF3-T	4N60KG-TF3-T	TO-220F3	G	D	S	Tube
4N60KL-TM3-T	4N60KG-TM3-T	TO-251	G	D	S	Tube
4N60KL-TMS-T	4N60KG-TMS-T	TO-251S	G	D	S	Tube
4N60KL-TMS2-T	4N60KG-TMS2-T	TO-251S2	G	D	S	Tube
4N60KL-TMS4-T	4N60KG-TMS4-T	TO-251S4	G	D	S	Tube
4N60KL-TN3-R	4N60KG-TN3-R	TO-252	G	D	S	Tape Reel
4N60KL-TND-R	4N60KG-TND-R	TO-252D	G	D	S	Tape Reel
4N60KL-T2Q-T	4N60KG-T2Q-T	TO-262	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source



(1) T: Tube, R: Tape Reel
(2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2, TF3: TO-220F3, TM3: TO-251 TMS: TO-251S, TMS2: TO-251S2, TMS4: TO-251S4, TN3: TO-252, TND: TO-252D T2Q: TO-262
(3) L: Lead Free, G: Halogen Free and Lead Free

■ MARKING



■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	600	V
Gate-Source Voltage		V_{GSS}	±30	V
Avalanche Current (Note 2)		I_{AR}	4.4	A
Drain Current	Continuous	I_D	4.0	A
	Pulsed (Note 2)	I_{DM}	16	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	210	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Power Dissipation	TO-220/TO-262	P_D	106	W
	TO-220F/TO-220F1 TO-220F2/TO-220F3		36	
	TO-251/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D		50	
Junction Temperature		T_J	+150	°C
Operating Temperature		T_{OPR}	-55 ~ +150	°C
Storage Temperature		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating : Pulse width limited by maximum junction temperature
3. L = 26.25mH, I_{AS} = 4A, V_{DD} = 50V, R_G = 25 Ω, Starting T_J = 25°C
4. I_{SD}≤4.4A, di/dt ≤200A/μs, V_{DD}≤BV_{DSS}, Starting T_J = 25°C

■ THERMAL DATA

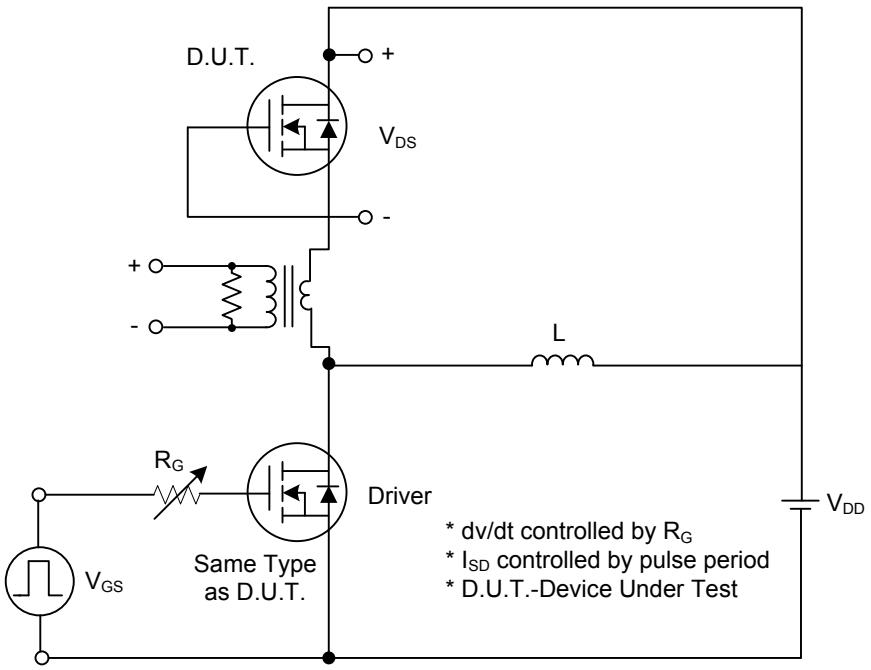
PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2 TO-220F3/TO-262	θ_{JA}	62.5	°C/W
	TO-251/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D		110	°C/W
Junction to Case	TO-220/TO-262	θ_{JC}	1.18	°C/W
	TO-220F/TO-220F1 TO-220F3		3.47	°C/W
	TO-220F2		3.4	°C/W
	TO-251/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D		2.50	°C/W

■ ELECTRICAL CHARACTERISTICS (T_C =25°C, unless otherwise specified)

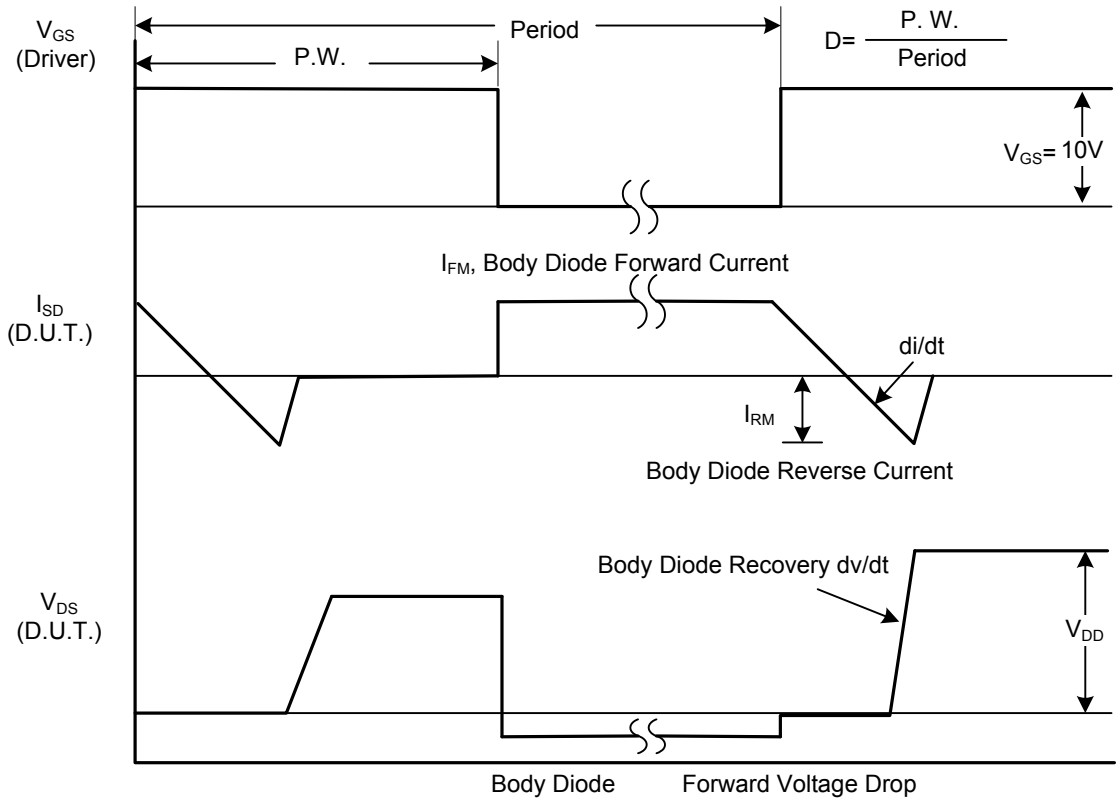
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	V_{GS}=0V, I_D=250μA	600			V
Drain-Source Leakage Current		I_{DSS}	V_{DS}=600V, V_{GS}=0V			10	μA
			V_{DS}=600V, V_{GS}=0V, T_C=125°C			10	μA
Gate-Source Leakage Current	Forward	I_{GSS}	V_{GS}=30V, V_{DS}=0V			100	nA
	Reverse		V_{GS}= -30V, V_{DS}=0V			-100	nA
Breakdown Voltage Temperature Coefficient		$\triangle BV_{DSS}/\triangle T_J$	I_D=250μA,Referenced to 25°C		0.6		V/°C
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	V_{DS}=V_{GS}, I_D=250μA	2.0		4.0	V
Static Drain-Source On-State Resistance		$R_{DS(ON)}$	V_{GS}=10 V, I_D=2.2A		1.79	2.5	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C_{ISS}	V_{DS} = 25V, V_{GS} = 0V, f = 1MHz		425	575	pF
Output Capacitance		C_{OSS}			55	75	pF
Reverse Transfer Capacitance		C_{RSS}			6	11	pF
SWITCHING CHARACTERISTICS							
Total Gate Charge		Q_G	V_{DS}= 50V,I_D= 1.3A, V_{GS}= 10V (Note 1, 2)		20		nC
Gate-Source Charge		Q_{GS}			5.6		nC
Gate-Drain Charge		Q_{GD}			4.0		nC
Turn-On Delay Time		$t_{D(ON)}$	V_{DD} = 30V, I_D = 0.5A, R_G = 25Ω (Note 1, 2)		45		ns
Turn-On Rise Time		t_R			49		ns
Turn-Off Delay Time		$t_{D(OFF)}$			80		ns
Turn-Off Fall Time		t_F			43		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Continuous Drain-Source Diode Forward Current		I_S				4.4	A
Maximum Pulsed Drain-Source Diode Forward Current		I_{SM}				17.6	A
Drain-Source Diode Forward Voltage		V_{SD}	V_{GS} = 0V, I_S = 4.4A			1.4	V

Notes: 1. Pulse Test: Pulse width≤300μs, Duty cycle≤2%
2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

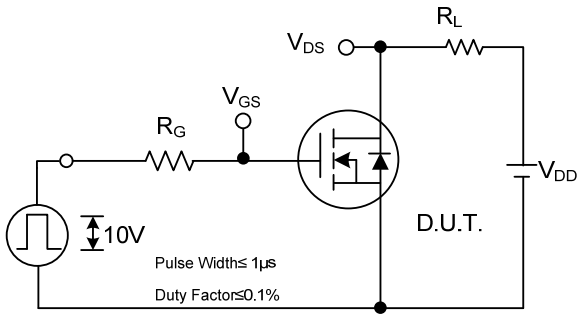


Peak Diode Recovery dv/dt Test Circuit

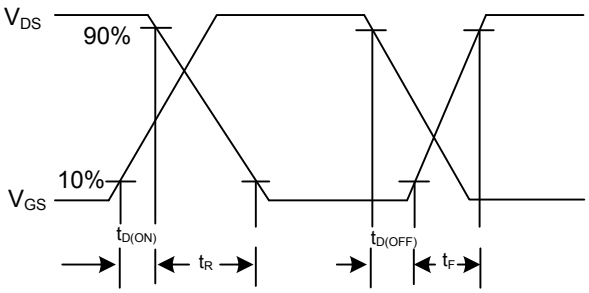


Peak Diode Recovery dv/dt Waveforms

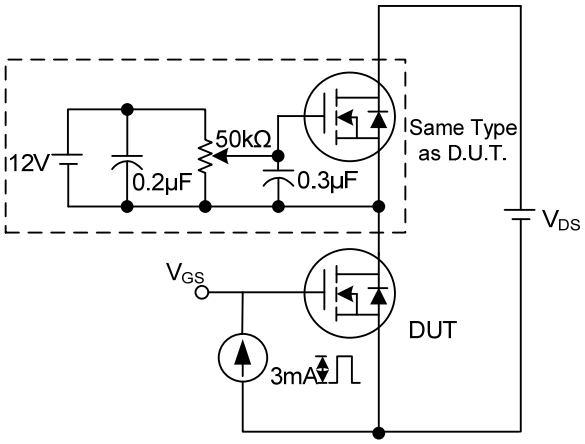
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



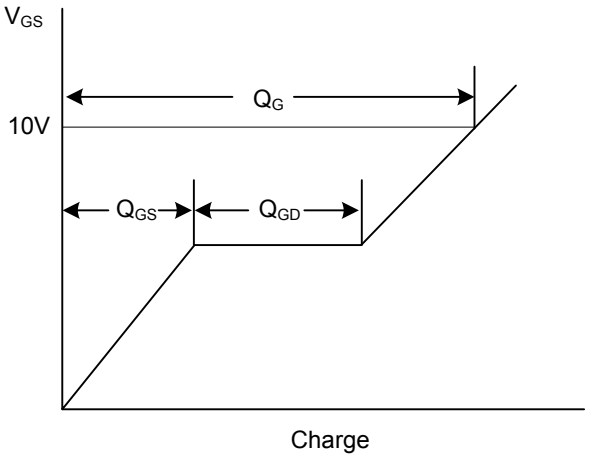
Switching Test Circuit



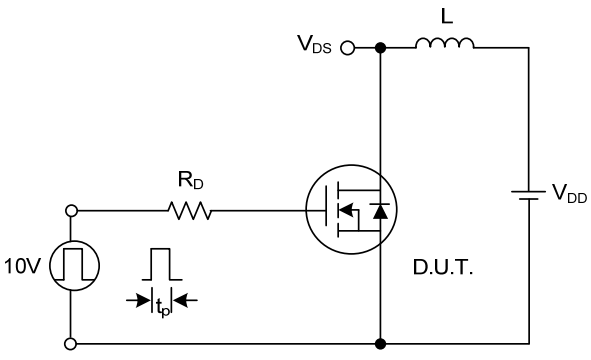
Switching Waveforms



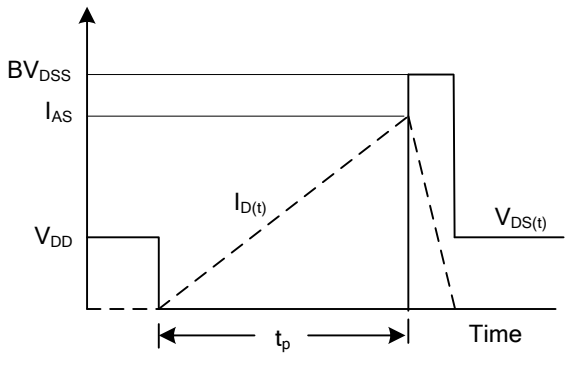
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms